

Form PTO-1449 (REV. 8-83)		US Dept. of Commerce PATENT & TRADEMARK OFFICE		ATTY DOCKET NO. 119333		APPLICATION NO. 10/815,833	
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)							
APPLICANTS Chiaki HAMADA et al.				FILING DATE April 2, 2004			
GROUP 3661							

U.S. PATENT DOCUMENTS						
EXAMINER INITIAL	1.	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS
<i>m</i>	1.	US 2001/0013722 A1	8/16/2001	UDAKA	—	—
<i>m</i>	2.	US 2002/0024252 A1	2/28/2002	BANNO et al.	—	—
<i>n</i>	3.	US 6,354,676 B1	3/12/2002	OSHIRO	—	—

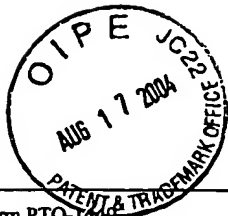
FOREIGN PATENT DOCUMENTS						
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		

EXAMINER <i>M. J. Wu</i>	DATE CONSIDERED <i>9/12/05</i>
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Examiner: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Date: October 5, 2004

Sheet 1 of 1Form PTO-1449
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APPLICANTS
Chiaki HAMADA et al.FILING DATE
April 2, 2004GROUP
3661

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS
<i>m</i>	1.	JP A 5-213169 w/abstract & transl.	8/24/1993	JAPAN	—	—
<i>m</i>	2.	JP A 2001-219834 w/abstract & transl.	8/14/2001	JAPAN	—	—
<i>m</i>	3.	JP A 2003-160039 w/abstract & transl.	6/3/2003	JAPAN	—	—

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

EXAMINER

mj

DATE CONSIDERED

9/12/05

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Date: August 17, 2004